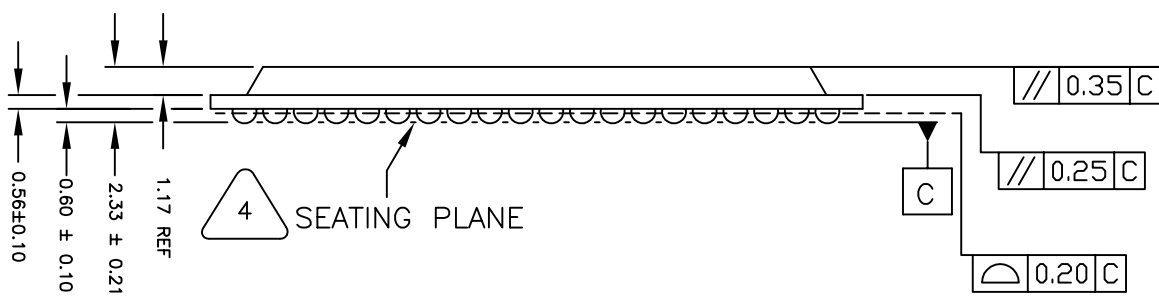
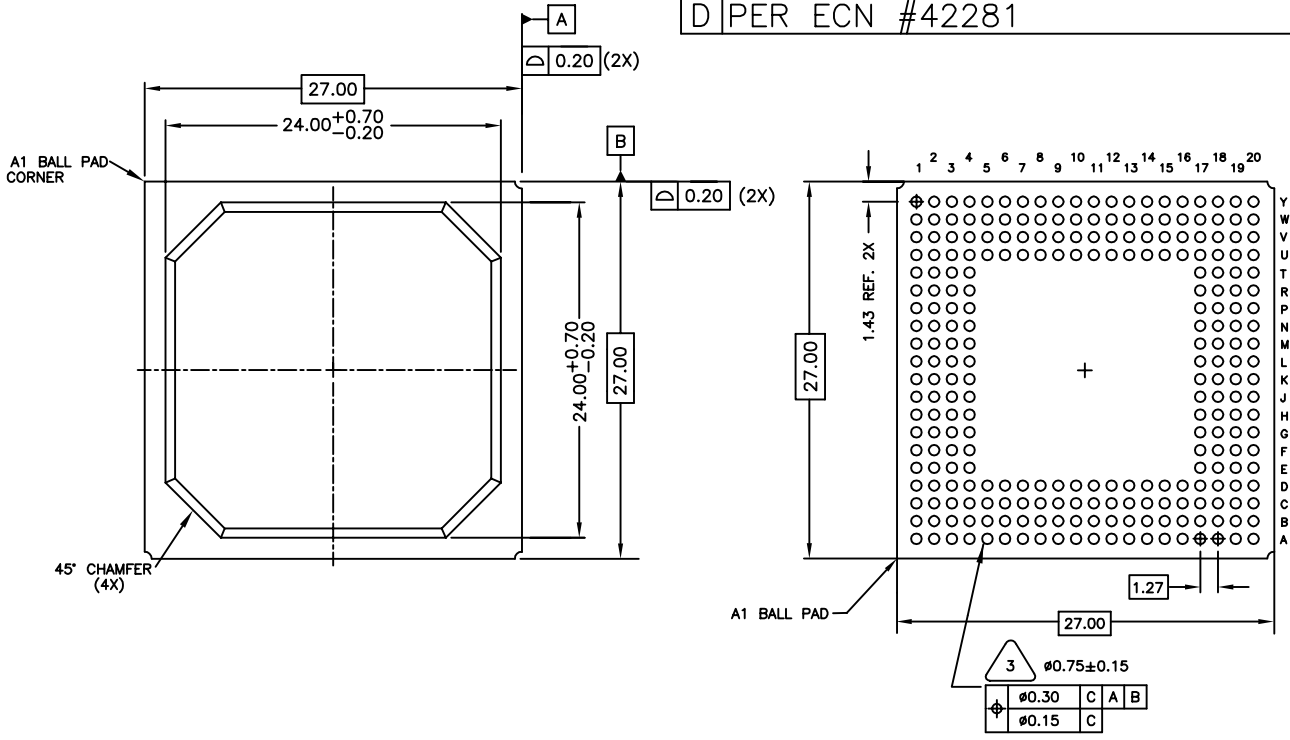


REVISIONS			
LTR.	DESCRIPTION	DATE	APPROVED
A	NEW DRAWING	5/98	
B	REVISE DWG PER ECN #24975	3/00	
C	REVISE DWG PER ECN #36527	08/03	
D	PER ECN #42281	11/04	



NOTES:

- DIMENSIONS ARE IN MILLIMETERS
- ALL DIMENSIONS AND TOLERANCE CONFORM TO ASME Y 14.5M-1994
- DIMENSION IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM
- PRIMARY DATUM AND SEATING PLANES ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

SIGNATURE		DATE					
DDC. CONTROL:				TITLE			
ENGR. MGR:				MARKETING OUTLINE, 256 LEAD, PBGA (27X27) 1.27 MM PITCH, 2.33 MM THICK, 4 LAYER			
MFG. ENGR:				SIZE	FSCM. NO.	PART NO.	REV.
CHECKED BY:	TWM	11/03		A		56-G6004-001	D
DRAWN BY:	JD	11/03		SCALE	N/A	SHEET	1 of 1